

PS8352AL2

ANALOG OUTPUT TYPE OPTICAL COUPLED ISOLATION AMPLIFIER

DESCRIPTION

The PS8352AL2 is an optically coupled isolation amplifier that uses an IC with a high-accuracy sigma-delta A/D converter and an AlGaAs light-emitting diode with high-speed response and high luminance efficiency on the input side, and an IC with a high-accuracy D/A converter on the output side.

The PS8352AL2 is designed specifically for high common mode transient immunity (CMTI) and high linearity (non-linearity). The PS8352AL2 is designed for current and voltage sensing.

FEATURES

- Non-linearity (NL200 = 0.35 % MAX.)
- High common mode transient immunity (CMTI = 10 kV/μs MIN.)
- High isolation voltage (BV = 5 000 Vr.m.s.)
- Gain tolerance (G = 7.92 to 8.08 (±1 %)) Gain: 8 V/V TYP.
- Package: 8-pin DIP lead bending type for long creepage distance for surface mount (L2)
- Embossed tape product: PS8352AL2-E3: 2 000 pcs/reel
- Pb-Free product
- Safety standards
 - UL approved: UL1577, Double protection
 - CSA approved: CAN/CSA-C22.2 62368-1, Reinforced insulation
 - VDE approved: DIN EN 60747-5-5 (Option)



- AC Servo, inverter
- Solar power conditioner
- Measurement equipment



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Start of mass production 2015-09



PACKAGE DIMENSIONS (UNIT: mm)

Lead Bending Type (Gull-wing) For Long Creepage Distance For Surface Mount (L2)



Weight: 0.316g (typ.)

PHOTOCOUPLER CONSTRUCTION

Parameter	MIN.
Air Distance	8 mm
Creepage Distance	8 mm
Isolation Distance	0.4 mm



MARKING EXAMPLE



ORDERING INFORMATION

Part Number	Order Number	Solder Plating Specification	Packing Style	Safety Standard Approval	Application Part Number*1
PS8352AL2	PS8352AL2-AX	Pb-Free (Ni/Pd/Au)	20 pcs (Tape 20 pcs cut)	Standard products (UL, CSA approved)	PS8352AL2
PS8352AL2-E3	PS8352AL2-E3-AX		Embossed Tape 2 000 pcs/reel		
PS8352AL2-V	PS8352AL2-V-AX		20 pcs (Tape 20 pcs cut)	UL, CSA, DIN EN 60747-5-5 approved	
PS8352AL2-V-E3	PS8352AL2-V-E3-AX		Embossed Tape 2 000 pcs/reel		

Notes*: 1 For the application of the Safety Standard, following part number should be used.



ABSOLUTE MAXIMUM RATINGS (T_A = 25 °C, unless otherwise specified)

Parameter	Symbol	Ratings	Unit
Operating Ambient Temperature	TA	- 40 to +110	°C
Storage Temperature	Tstg	– 55 to +125	°C
Supply Voltage	Vdd1, Vdd2	0 to 5.5	V
Input Voltage	VIN+, VIN-	– 2 to V _{DD1} +0.5	V
2 Seconds Transient Input Voltage	V _{IN+} , V _{IN-}	– 6 to V _{DD1} +0.5	V
Output Voltage	Vout+, Vout-	– 0.5 to V _{DD2} +0.5	V
Isolation Voltage ^{*1}	BV	5 000	Vr.m.s.

Notes*: 1. AC voltage for 1 minute at T_A = 25 °C , RH = 60 % between input and output. Pins 1-4 shorted together, 5-8 shorted together.

RECOMMENDED OPERATING CONDITIONS

Parameter	Symbol	MIN.	MAX.	Unit
Operating Ambient Temperature	TA	- 40	110	°C
Supply Voltage	Vdd1, Vdd2	4.5	5.5	V
Input Voltage (Accurate and Linear) ^{*1}	Vin+, Vin-	- 200	200	mV

Notes*: 1. Using V_{IN} = 0 V (to be connected to GND1) is recommended. Avoid using V_{IN} of 2.5 V or more, because the internal test mode is activated when the voltage V_{IN} reaches more than 2.5 V.



ELECTRICAL CHARACTERISTICS (DC Characteristics)

(TYP.: TA = 25 °C, VIN+ = VIN- = 0 V, VDD1 = VDD2 = 5 V, MIN., MAX.: refer to RECOMMENDED OPERATING CONDITIONS, unless otherwise specified)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Input Offset Voltage	Vos	T _A = 25 °C	- 2	- 0.25	2	mV
			- 3	- 0.25	3	1
Input Offset Voltage Drift vs. Temperature	dVos/dT _A			1.6	10	<i>μ</i> V/°C
Gain ^{*1}	G	$\label{eq:VIN+} \begin{array}{l} -200 \mbox{ mV} \leq V_{IN+} \leq 200 \mbox{ mV}, \\ T_A = 25 \mbox{ °C} \end{array}$	7.92	8	8.08	V/V
Gain Drift vs. Temperature	dG/dT _A			0.0006		V/V°C
Vout Non-linearity (200 mV) *2	NL200	$-\ 200\ mV \leq V_{IN^+} \leq 200\ mV$		0.014	0.35	%
Vout Non-linearity (200 mV) Drift vs. Temperature	dNL200/dT _A			0.0001		%/°C
Vout Non-linearity (100 mV)*2	NL100	$-100~mV \leq V_{IN^+} \leq 100~mV$		0.011	0.2	%
Maximum Input Voltage before Vout Clipping	V _{IN+} MAX.			320		mV
Input Supply Current	I _{DD1}	V _{IN+} = 400 mV		13.5	16	mA
Output Supply Current	I _{DD2}	V _{IN+} = - 400 mV		7.8	16	mA
Input Bias Current	I _{IN+}	$V_{IN+} = 0V$	– 1	- 0.65	1	μA
Input Bias Current Drift vs. Temperature	dl _{IN+} /dT _A			0.3		nA/°C
Low Level Saturated Output Voltage	Vol	V _{IN+} = - 400 mV		1.29		V
High Level Saturated Output Voltage	V _{он}	V _{IN+} = 400 mV		3.8		V
Output Voltage ($V_{IN^+} = V_{IN^-} = 0 V$)	Vосм	V _{IN+} = V _{IN-} = 0 V	2.2	2.55	2.8	V
Output Short-circuit Current	losc			20		mA
Equivalent Input Resistance	R _{IN}			450		kΩ
Vout Output Resistance	Rout			4		Ω
Input DC Common-Mode Rejection Ratio ^{*3}	CMRRIN			76		dB

- *1 The differential output voltage $(V_{OUT+} V_{OUT-})$ with respect to the differential input voltage $(V_{IN+} V_{IN-})$, where $V_{IN+} = -200 \text{ mV}$ to 200 mV and $V_{IN-} = 0 \text{ V}$) is measured under the circuit shown in **Fig. 2 NL200, G Test Circuit**. Upon the resulting chart, the gain is defined as the slope of the optimum line obtained by using the method of least squares.
- *2 The differential output voltage $(V_{OUT+} V_{OUT-})$ with respect to the differential input voltage $(V_{IN+} V_{IN-})$ is measured under the circuit shown in **Fig. 2 NL200**, **G Test Circuit**. Upon the resulting chart, the optimum line is obtained by using the method of least squares. Non-linearity is defined as the ratio (%) of the optimum line obtained by dividing [Half of the peak to peak value of the (residual) deviation] by [full-scale differential output voltage]. For example, if the differential output voltage is 3.2 V, and the peak to peak value of the (residual) deviation is 22.4 mV, while the input V_{IN+} is ±200 mV, the output non-linearity is obtained as follows: NL200 = 22.4/(2 × 3 200) = 0.35%
- *3 CMRR_{IN} is defined as the ratio of the differential signal gain (when the differential signal is applied between the input pins) to the common-mode signal gain (when both input pins are connected and the signal is applied). This value is indicated in dB.



ELECTRICAL CHARACTERISTICS (AC Characteristics)

(TYP.: TA = 25 °C, VIN+ = VIN- = 0 V, VDD1 = VDD2 = 5 V, MIN., MAX.: refer to RECOMMENDED OPERATING CONDITIONS, unless otherwise specified)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
V _{OUT} Bandwidth (– 3 dB)	f _C	V _{IN+} = 200 mVp-p, sine wave	50	100		kHz
V _{OUT} Noise	Νουτ	V _{IN+} = 0 V		15.6		mVr.m.s.
V _{IN} to V _{OUT} Signal Delay (50 to 10%)	t _{PD10}	V _{IN+} = 0 to 150 mV step		2.4	3.3	μs
V _{IN} to V _{OUT} Signal Delay (50 to 50%)	t _{PD50}			4.2	5.6	
V _{IN} to V _{OUT} Signal Delay (50 to 90%)	t _{PD90}			6.1	9.9	
V _{OUT} Rise Time/Fall Time (10 to 90%)	t _r /t _f	V _{IN+} = 0 to 150 mV step		3.1	6.6	μs
Common Mode Transient Immunity ^{*1}	CMTI	V_{CM} = 0.5 kV, t _r = 20 ns, T _A = 25 °C	10	28		kV/ <i>μ</i> s
Power Supply Noise Rejection ^{*2}	PSR	f = 1 MHz		40		mVr.m.s.

*1 CMTI is tested by applying a pulse that rises and falls suddenly ($V_{CM} = 0.5 \text{ kV}$) between GND1 on the input side and GND2 on the output side (pins 4 and 5) by using the circuit shown in **Fig. 9 CMTI Test Circuit**. CMTI is defined at the point where the differential output voltage ($V_{OUT+} - V_{OUT-}$) fluctuates 200 mV (>1 μ s) or more from the average output voltage.

*2 This is the value of the transient voltage at the differential output when 1 V_{p-p}, 1 MHz, and 40 ns rise/fall time square wave is applied to both V_{DD1} and V_{DD2}.



TEST CIRCUIT







TYPICAL CHARACTERISTICS (T_A = 25 °C unless otherwise specified)



Remark The graphs indicate nominal characteristics.





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Remark The graphs indicate nominal characteristics.



TAPING SPECIFICATIONS (UNIT: mm)





RECOMMENDED MOUNT PAD DIMENSIONS (UNIT: mm)



[8pin SDIP (L2)]

Remark All dimensions in this figure must be evaluated before use.



NOTES ON HANDLING

- 1. Recommended soldering conditions
 - (1) Infrared reflow soldering
 - Peak reflow temperature
 - Time of peak reflow temperature
 - Time of temperature higher than 220 °C
 - Time to preheat temperature from 120 to 180 °C
 - Number of reflows
 - Flux •

 120 ± 30 s

10 seconds or less

60 seconds or less

Three

Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

260 °C or below (package surface temperature)

Recommended Temperature Profile of Infrared Reflow



Time (s)

(2) Wave soldering

- Temperature 260 °C or below (molten solder temperature) •
- Time 10 seconds or less
- Preheating conditions 120 °C or below (package surface temperature)
- Number of times One (Allowed to be dipped in solder including plastic mold portion.)
 - Rosin flux containing small amount of chlorine (The flux with a maximum Flux chlorine content of 0.2 Wt% is recommended.)

(3) Soldering by Soldering Iron

- Peak Temperature (lead part temperature) 350 °C or below
 - 3 seconds or less
- Time (each pins) Flux Rosin flux containing small amount of chlorine
 - (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)
- (a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead
- (b) Please be sure that the temperature of the package would not be heated over 100°C

(4) Cautions

- Flux Cleaning
 - Avoid cleaning with Freon based or halogen-based (chlorinated etc.) solvents.
- Do not use fixing agents or coatings containing halogen-based substances.



2. Cautions regarding noise

Be aware that when voltage is applied suddenly between the photocoupler's input and output at startup, the output transistor may enter the on state, even if the voltage is within the absolute maximum ratings.

USAGE CAUTIONS

- 1. Usage cautions
 - (1) This product is weak for static electricity by designed with high-speed integrated circuit so protect against static electricity when handling.
 - (2) When the primary power supply (VDD1) is off and only the secondary power supply (VDD2) is being applied (VDD1 = 0 V and VDD2 = 5 V), VOUT+ outputs a low level, and VOUT- outputs a high level (VOUT+ = 1.3 V TYP., VOUT- = 3.8 V TYP.), regardless of the input voltages (VIN+ and VIN-).
 - (3) The output level of VouT+ and VouT- might be unstable for several seconds immediately after the secondary power supply (VDD2) is applied while the primary power supply (VDD1) is being applied.

2. Board designing

- (1) By-pass capacitor of more than 0.1 μ F is used between Vcc and GND near device. Also, ensure that the distance between the leads of the photocoupler and capacitor is no more than 10 mm.
- (2) Keep the pattern connected the input (VIN+, VIN-) and the output (VOUT+, VOUT-), respectively, as short as possible.
- (3) Do not connect any routing to the portion of the frame exposed between the pins on the package of the photocoupler. If connected, it will affect the photocoupler's internal voltage and the photocoupler will not operate normally.
- (4) Because the maximum frequency of the signal input to the photocoupler must be lower than the allowable frequency band, be sure to connect an anti-aliasing filter (an RC filter with R = 68 Ω and C = 0.01 μ F, for example).
- (5) The signals output from the PS8352A include noise elements such as chopping noise and quantization noise generated internally. Therefore, be sure to restrict the output frequency to the required bandwidth by adding a low-pass filter function (an RC filter with R =10 kΩ and C = 150 pF, for example) to the operational amplifier (post amplifier) in the next stage to the PS8352A.
- **3.** Avoid storage at a high temperature and high humidity.



SPECIFICATION OF VDE MARKS LICENSE DOCUMENT

Parameter	Symbol	Speck	Unit
Climatic test class (IEC 60068-1/DIN EN 60068-1)		40/110/21	
Dielectric strength			
maximum operating isolation voltage	UIORM	1 130	Vpeak
Test voltage (partial discharge test, procedure a for type test and random test)	Upr	1 808	V _{peak}
U_{pr} = 1.6 × UIORM, Pd < 5 pC			
Test voltage (partial discharge test, procedure b for all devices)	Upr	2 119	Vpeak
Upr = 1.875 × UIORM, Pd < 5 pC	- 1	-	
Highest permissible overvoltage	Uютм	8 000	Vpeak
Degree of pollution (IEC 60664-1/DIN EN 60664-1 (VDE 0110-1))		2	
Comparative tracking index (IEC 60112/DIN EN 60112 (VDE 0303 Part 11))	СТІ	175	
Material group (IEC 60664-1/DIN EN 60664-1 (VDE 0110-1))		lll a	
Storage temperature range	Tstg	-55 to +125	°C
Operating temperature range	TA	-40 to +110	°C
Isolation resistance, minimum value			
$V_{IO} = 500 \text{ V} \text{ dc} \text{ at } T_A = 25^{\circ}\text{C}$	Ris MIN.	10 ¹²	Ω
V _{IO} = 500 V dc at T _A MAX. at least 100°C	Ris MIN.	10 ¹¹	Ω
Safety maximum ratings (maximum permissible in case of fault, see thermal			
derating curve)			
Package temperature	Tsi	175	°C
Current (input current I⊧, Psi = 0)	Isi	400	mA
Power (output or total power dissipation)	Psi	700	mW
Isolation resistance			
V _{IO} = 500 V dc at T _A = Tsi	Ris MIN.	10 ⁹	Ω

Dependence of maximum safety ratings with package temperature





Method a Destructive Test, Type and Sample Test



Method b Non-destructive Test, 100% Production Test



 $\begin{array}{l} t_{3}, t_{4} = 0.1 \; \text{sec} \\ t_{m}(\text{PARTIAL DISCHARGE})^{=} \; 1.0 \; \text{sec} \\ t_{test} = 1.2 \; \text{sec} \end{array}$



Caution GaAs Products	This product uses gallium arsenide (GaAs). GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.
	• Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.
	 Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.
	2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.
	Do not burn, destroy, cut, crush, or chemically dissolve the product.
	• Do not lick the product or in any way allow it to enter the mouth.



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